Docket No.:		
DECLARAT	ION AND POWER	OF ATTORNEY
As a below named inventor, I hereby o	declare that:	
My residence, post office and citizensh	nip are as stated below next to my	name,
inventor (if plural names are listed be	low) of the subject matter claim	s listed below) or an original, first and jo ted and for which a patent is sought on , the specification of which
		plication Serial No and was
	(if applicab	
I hereby state that I have reviewed an claims, as amended by any amendment	d understand the contents of the	above identified specification, including
I acknowledge the duty to disclose inf with Title 37, Code of Federal Regulat	ormation which is known to me ions, Section 1.56(a).	to be material to patentability in accordan
or inventor's certificate, or 365(a) of ar than the United States of America, list	ny PCT international application ved below and have also identified tificate, or of any PCT internation	5 (b) of any foreign application(s) for pate which designated at least one country othe below, by checking the box, any foreign nal application having a filing date before
Prior Foreign Application(s): Number	Country	Foreign Filing Date <u>Month/Day/Year</u>
74372/2003	Korea	10/23/2003
I hereby claim the benefit under 35 U.	S.C. 119(e) of any United States p	rovisional application(s) listed below.
Application Number(s):	Filing Date (Month/Day/Year)	
each of the claims of this application it the manner provided by the first parag	te United States of America, listed s not disclosed in the prior Unite traph of 35 U.S.C. 112, I acknowl in 37 CFR 1.56 which became a	ates application(s), or 365(c) of any Pode below and, insofar as the subject mattered States or PCT international application ledge the duty to disclose information who vailable between the filing date of the prication.
Prior U. S. Application of PCT Parent Number Fil	ling Date (Month/Day/Year)	Parent Patent Number (if applicable
PCT/KR2004/002373	September 16, 2004	A STATE OF THE PARTY OF THE PAR

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

I hereby appoint the following attorney(s) and/or agent(s) associated with Customer Number 34610 with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith. <u>Direct all correspondence to Customer Number 34610</u>.

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